

ACE1V3225

Automotive grade common-mode chip inductor



Product features

- AEC-Q200 qualified
- 1210 (3225 metric) package
- Impedance range from 500 ohms to 15000 ohms
- Inductance range from 11 uH to 200 uH
- Moisture sensitivity level (MSL): 1

Applications

- Controller area network (CAN)
- Ethernet architectures
- Automotive signal line filter
- Advanced driver assistance systems (ADAS)
- Infotainment, safety cameras, sensors, xEV, Powertrain
- Engine control unit (ECU)
- Electric power steering system (EPS)
- Battery management systems (BMS)

Environmental compliance and general specifications

- Operating temperature range: -40 °C to +125 °C (ambient plus self-temperature rise)
- Solder reflow temperature: J-STD-020 (latest revision) compliant

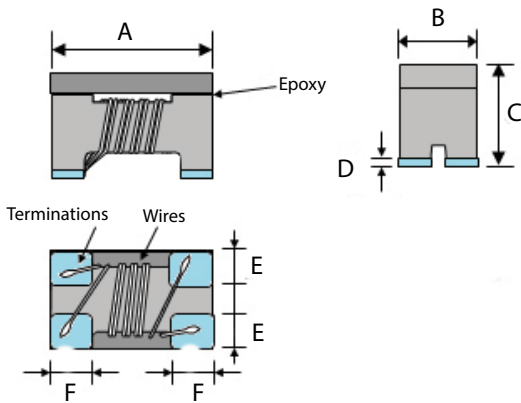


Product specifications

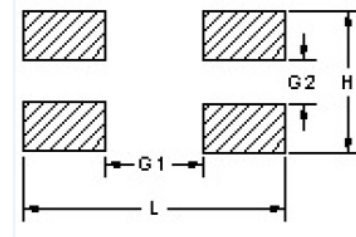
Part number	Common-mode impedance Z (Ω) at 10 MHz	Common-mode inductance (μH) at 100 kHz	DCR (Ω) @ +25 ° maximum	Idc (mA) maximum	Rated voltage (Vdc) typical	Insulation resistance (M Ω) minimum
ACE1V3225-110-R	300 minimum 500 typical	11+50%/-30%	0.40	300	80	10
ACE1V3225-220-R	500 minimum 1000 typical	22+50%/-30%	0.50	250	80	10
ACE1V3225-510-R	1000 minimum 2600 typical	51+50%/-30%	0.70	200	80	10
ACE1V3225-101-R	2200 minimum 5100 typical	100+50%/-30%	1.50	150	80	10
ACE1V3225-201-R	NA	200+30%/-20%	4.80	70	80	10

1. Part Number Definition: ACE1V3225-xxn-R
ACE1V3225 = Product code and size
xx= inductance value in μH ,
n= multiplication factor: 10^n (i.e. 110 = $11 \times 10^0 = 11 \mu\text{H}$)
-R suffix = RoHS compliant

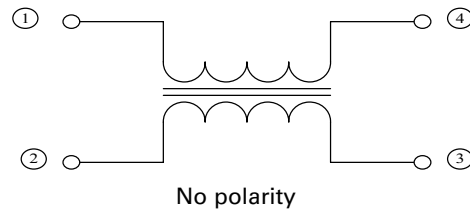
Mechanical parameters, schematic, pad layout (mm)



Recommended pad layout



Equivalent circuit

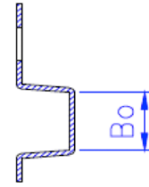
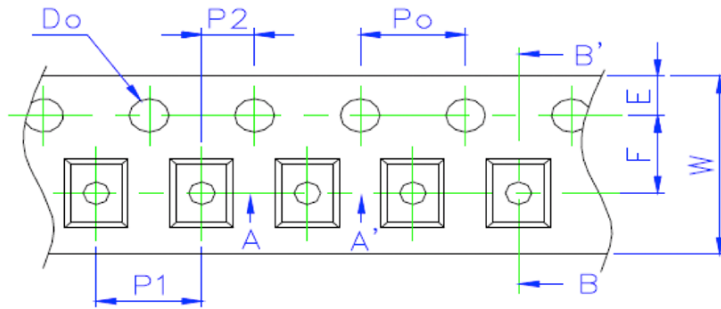


Part number	A	B	C	D	E	F	L	H	G1	G2
ACE1V3225-xxn-R	3.2±0.2	2.5±0.2	2.5 max	0.2±0.1	0.9 typ	08 typ	3.7 typ	2.55 typ	1.9 typ	0.75 typ

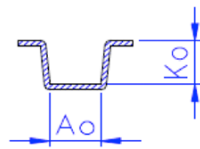
All soldering surfaces to be coplanar within 0.1 millimeters
Tolerances are ±0.1 millimeters unless stated otherwise
Pad layout dimensions are reference only
Traces or vias underneath the inductor is not recommended

Packaging information (mm)

Supplied in tape and reel packaging, 1000 parts per 7" diameter reel



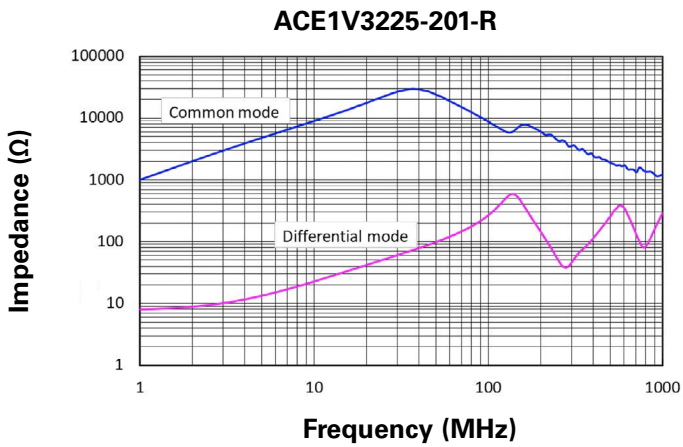
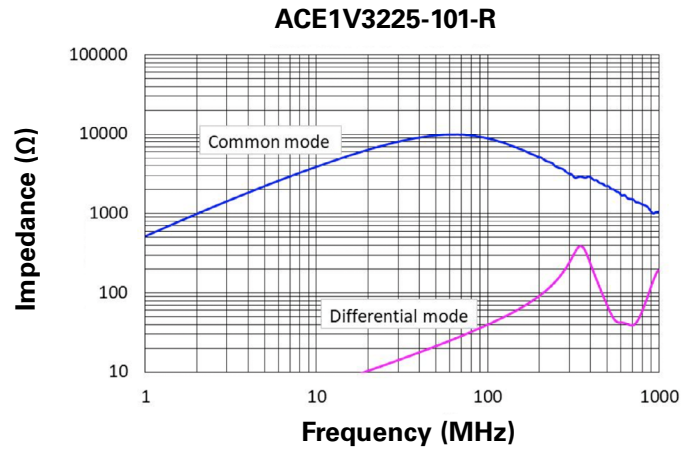
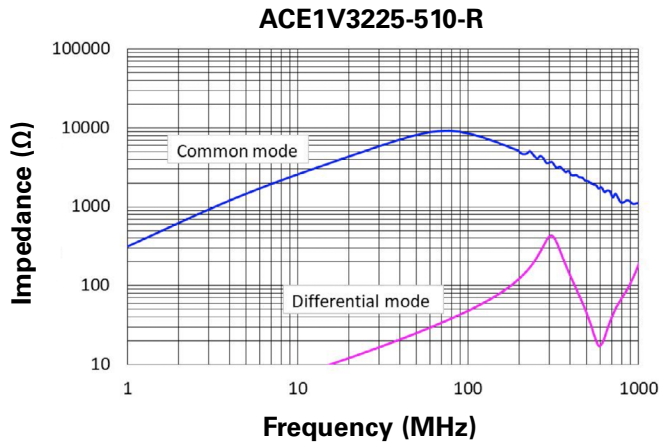
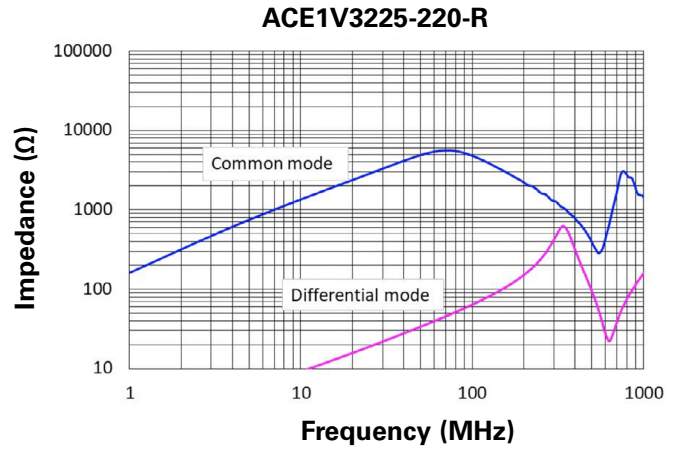
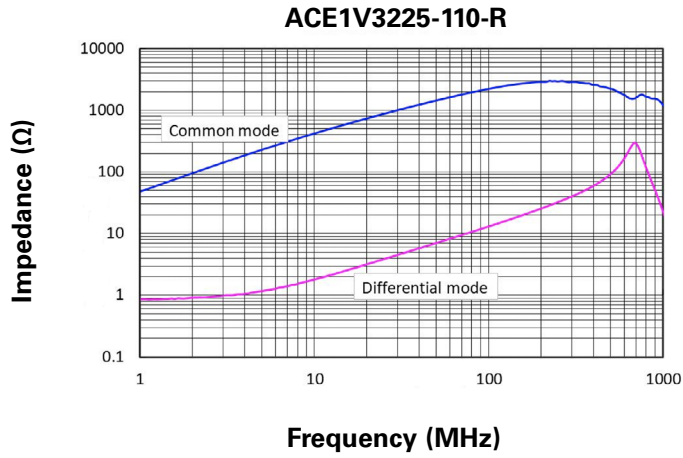
SEC: B-B'



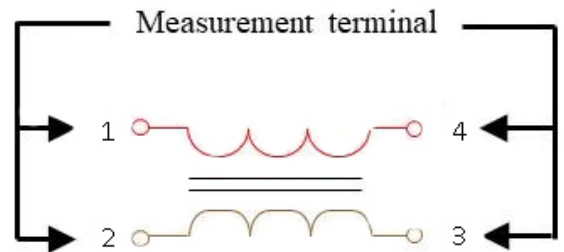
SEC: A-A'

Ao	2.80±0.10
Bo	3.60±0.10
Ko	2.20±0.10
W	8.00±0.20
E	1.75±0.10
F	3.50±0.05
Po	4.0±0.05
P1	4.0±0.10
Do	1.0±0.1

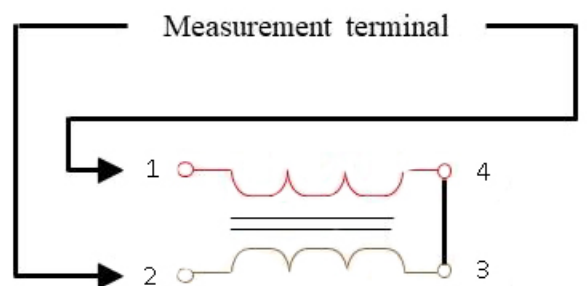
Performance curves



Common mode measurement method:



Differential mode measurement method:



Solder reflow profile

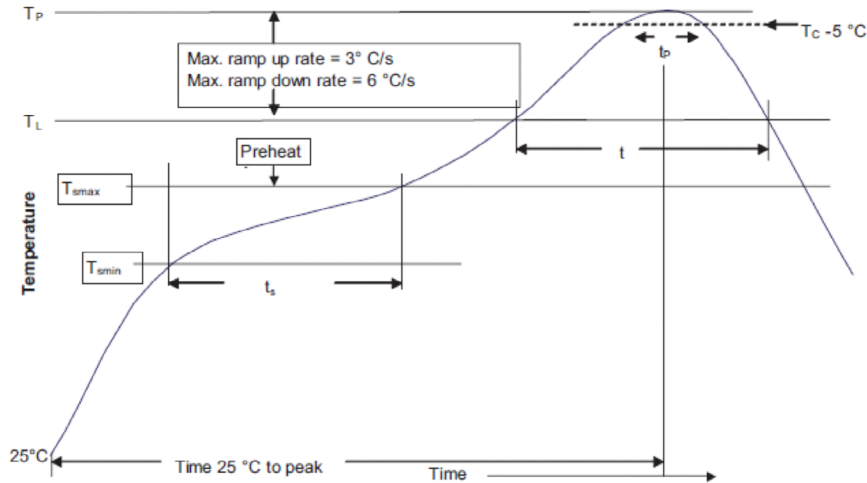


Table 1 - Standard SnPb solder (T_C)

Package thickness	Volume mm ³ <350	Volume mm ³ ≥350
<2.5 mm)	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2 - Lead (Pb) free solder (T_C)

Package thickness	Volume mm ³ <350	Volume mm ³ 350 - 2000	Volume mm ³ >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 – 2.5 mm	260 °C	250 °C	245 °C
>2.5 mm	250 °C	245 °C	245 °C

Reference J-STD-020

Profile feature	Standard SnPb solder	Lead (Pb) free solder
Preheat and soak		
• Temperature min. (T_{smin})	100 °C	150 °C
• Temperature max. (T_{smax})	150 °C	200 °C
• Time (T_{smin} to T_{smax}) (t_s)	60-120 seconds	60-120 seconds
Ramp up rate T_L to T_p	3 °C/ second max.	3 °C/ second max.
Liquidous temperature (T_L)	183 °C	217 °C
Time (t_L) maintained above T_L	60-150 seconds	60-150 seconds
Peak package body temperature (T_p)*	Table 1	Table 2
Time (t_p)* within 5 °C of the specified classification temperature (T_C)	20 seconds*	30 seconds*
Ramp-down rate (T_p to T_L)	6 °C/ second max.	6 °C/ second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

* Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and a user maximum.

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Eaton
Electronics Division
1000 Eaton Boulevard
Cleveland, OH 44122
United States
Eaton.com/electronics

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